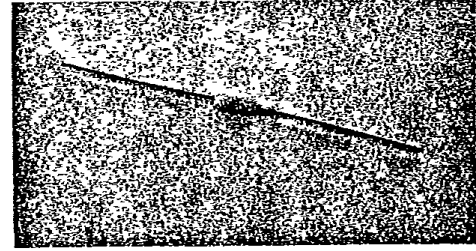




High Voltage Rectifier H 1746 Series

January 1984

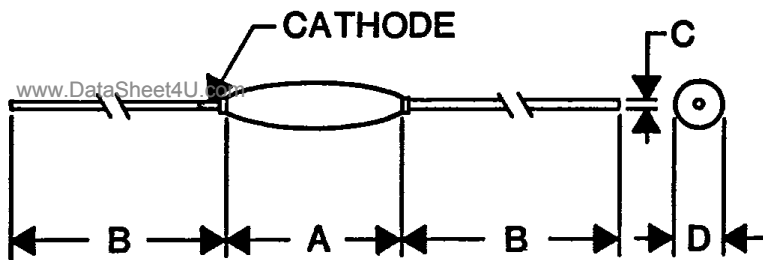
- Glass Passivated
- Glass Encapsulated
- Platinum Doped
- Aluminum Bonded
- Uniform Chip-To-Chip Recovery



MAXIMUM RATINGS (At $T_A = 25^\circ\text{C}$ unless otherwise noted)	SYMBOL	-25	-24	-23	-22	-21	UNITS	
Repetitive Peak Reverse Voltage*	V_{RRM}	25	24	23	22	21	kV	
Forward Current, Repetitive Peak	I_{FRM}	100						mA
Forward Current (Total RMS)	$I_{F(RMS)}$	10						mA
Average Rectified Forward Current, 15.75 kHz, 15% duty cycle, capacitive load	$I_{F(AV)}$	1.5						mA
Operating Junction Temperature	T_J	-40 to +110						$^\circ\text{C}$
Operating Case Temperature	T_C	-40 to +100						$^\circ\text{C}$
Storage Temperature	T_{STG}	-40 to +150						$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS (At $T_A = 25^\circ\text{C}$ unless otherwise noted)	SYMBOL		UNITS
Max. Forward Voltage, @ $I_F = 5\text{ mA}$	V_F	70	V
Max. Reverse Current, @ $V_R = \text{Rated } V_{RRM}^*$	I_R	2	μA
Max. Reverse Recovery Time (Circuit Fig. 2)	t_{rr}	175 max. 100 typical	ns
Max. Junction Capacitance, $f = 100\text{ kHz}$, $V_R = 100\text{ VDC}$	C_J	0.4	pF
Soldering Temperature = 260°C Max. for 10 sec. Max., 0.125 inch min. from glass			

*For reverse voltage testing, the rectifier must be in a suitable dielectric such as oil, pressurized nitrogen, epoxy, or Fluorinert FC 43.



NOMINAL DIMENSIONS		
LTR	INCHES	MILLIMETERS
A	.460 ± .030	11,68 ± 0,76
B	1.19 ± .03	30,23 ± 0,76
C	.0236 ± .0015	0,6 ± 0,04
D	.135 MAX.	3,43 MAX.

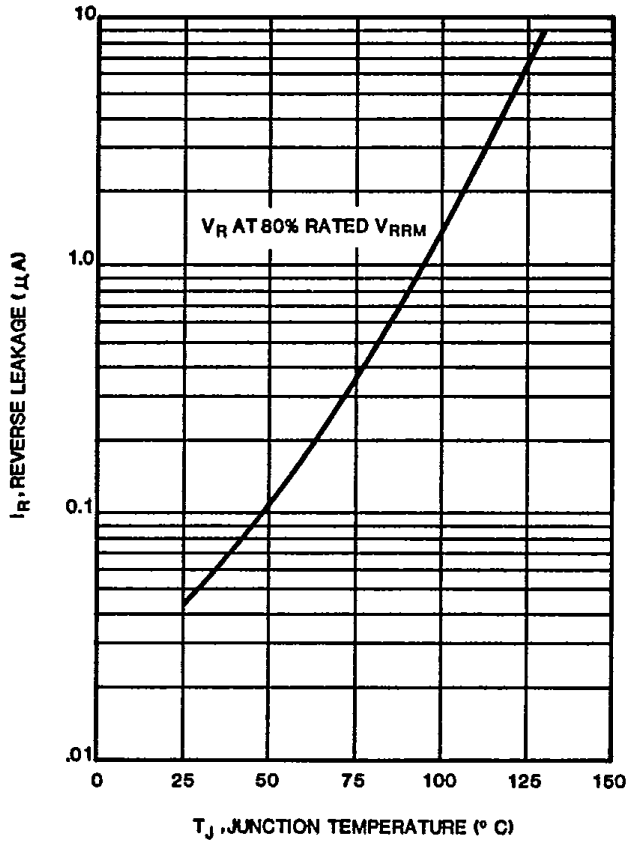


FIG. 1

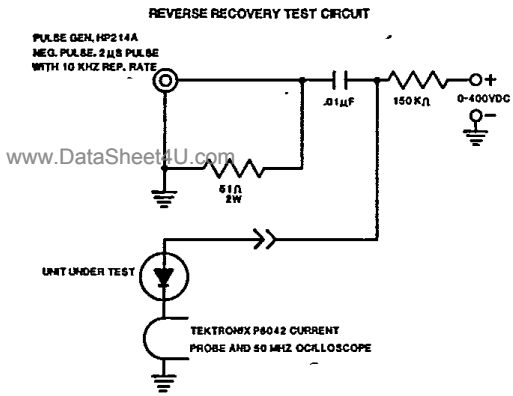


FIG. 2A

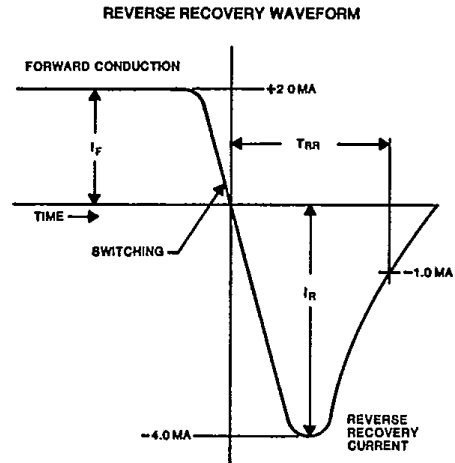


FIG. 2B